

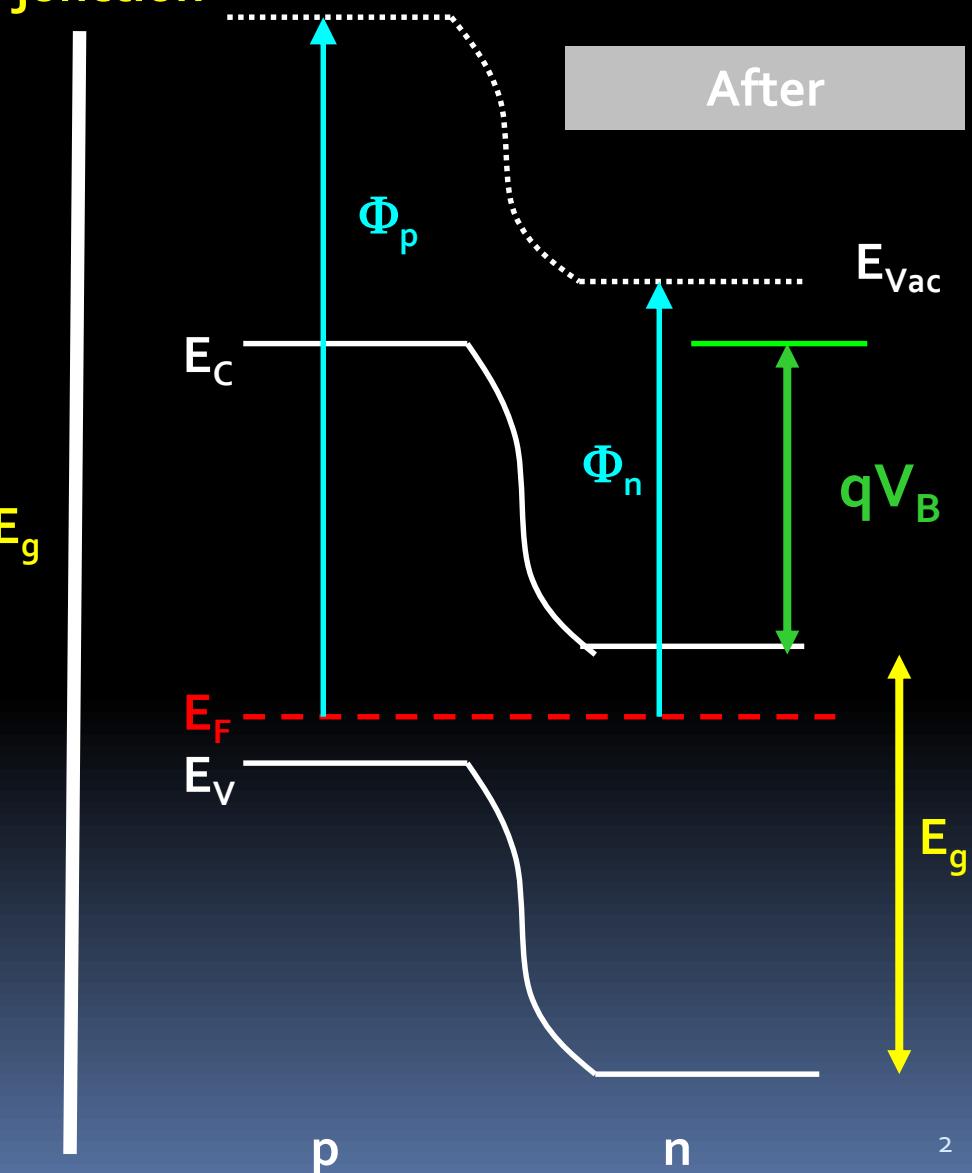
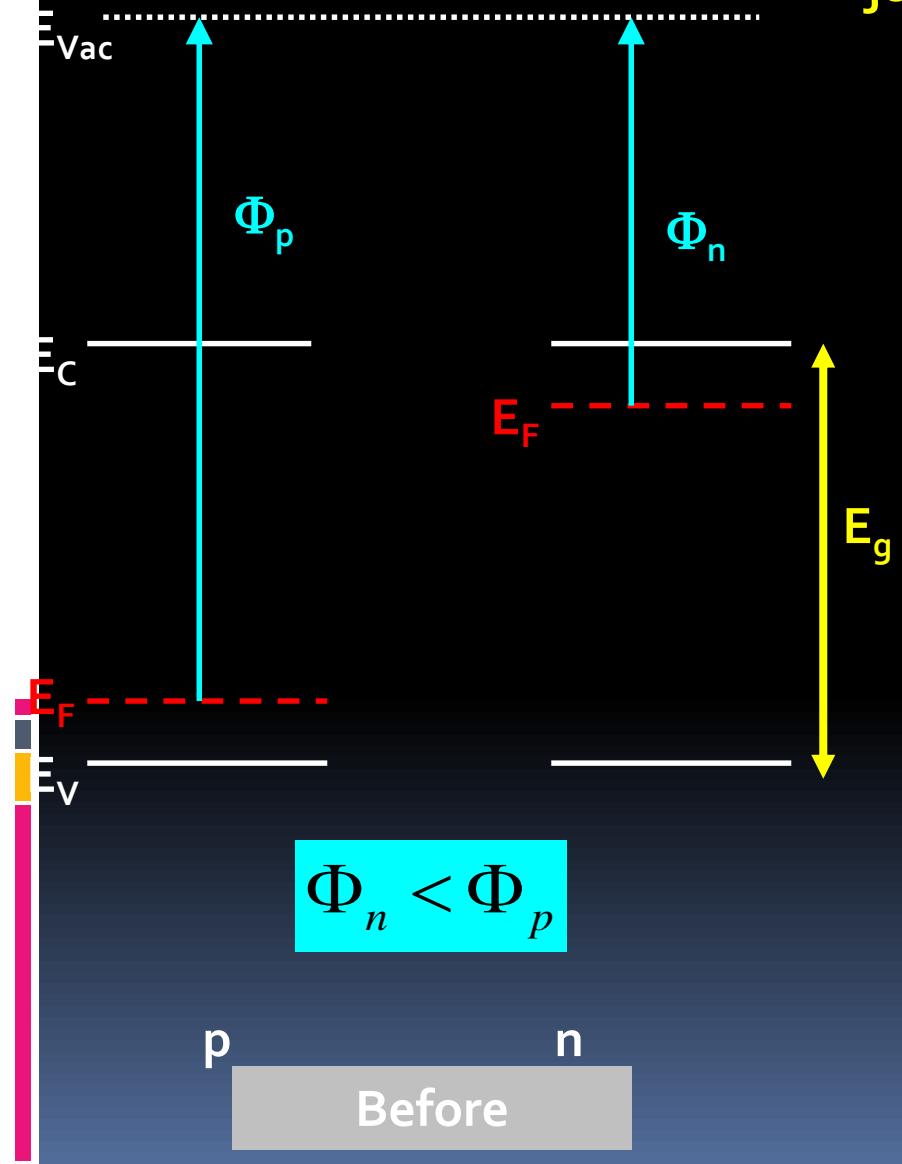
D I O D E S -02

Shouvik Datta

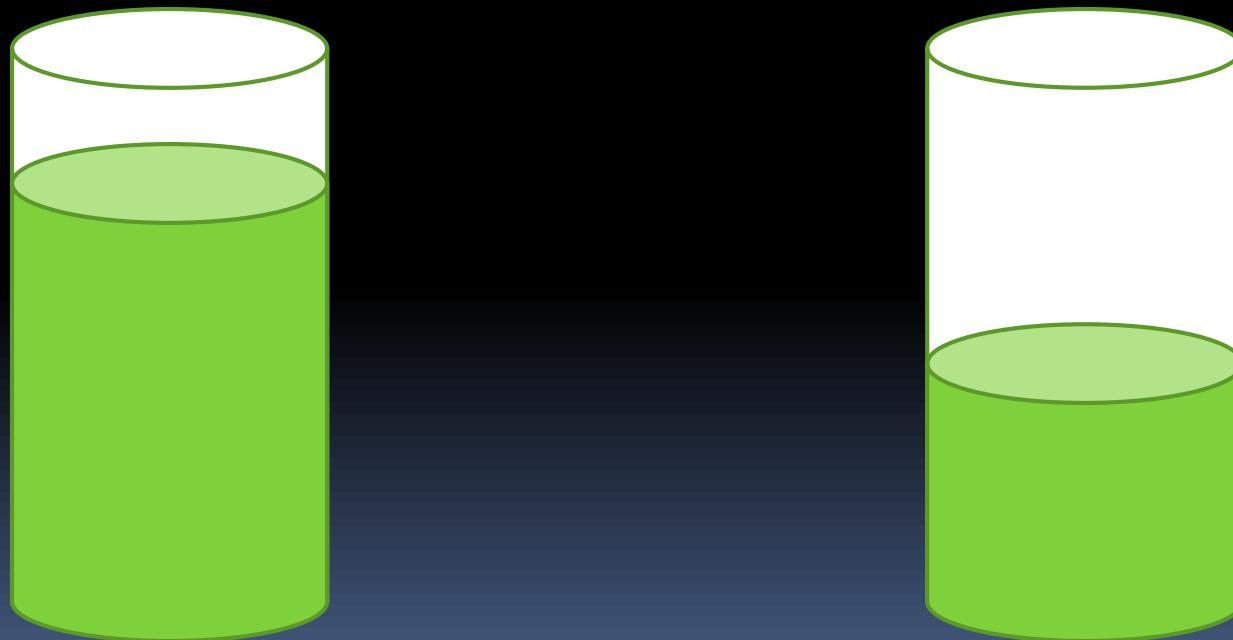
Electronics, PH3144  
IISER-Pune

# RECAPITULATION

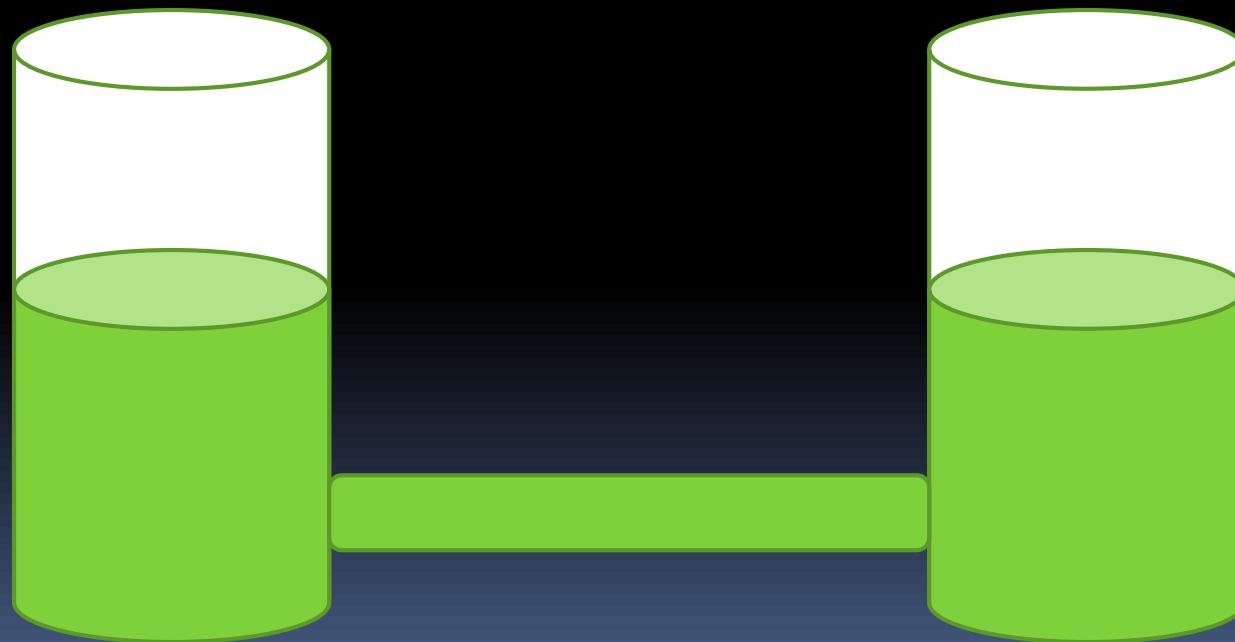
Spatial Variation of Potential Energy  $\equiv$  Presence of an electric Field at the junction



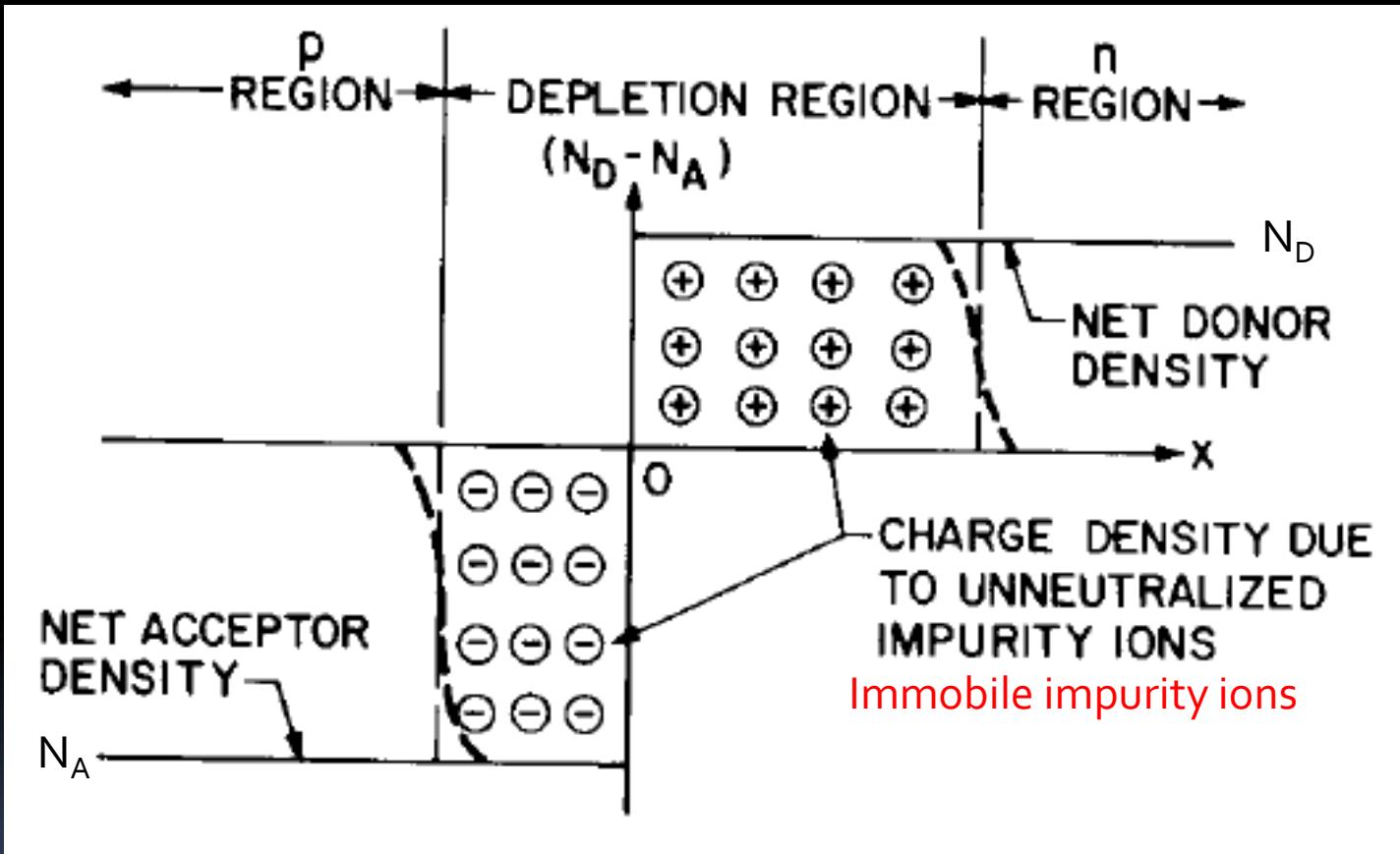
**REMEMBER  
THE ANALOGY OF WATER LEVELS IN  
TWO BEAKERS**



**REMEMBER  
THE ANALOGY OF WATER LEVELS IN  
TWO BEAKERS AT EQUILIBRIUM AFTER  
THEY ARE JOINED TOGETHER.**

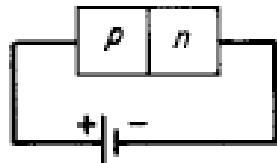


# RECAPITULATION



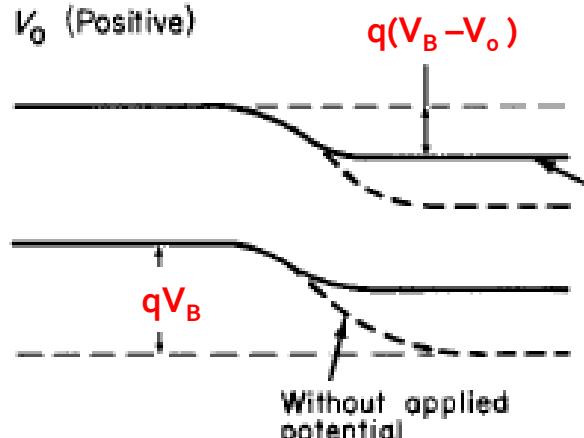
Depletion Region : Depleted of Free Mobile Charge Carriers  
( either e or h )

# RECAPITULATION

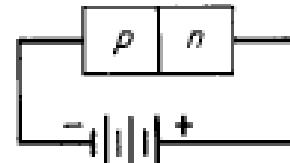


$V_o$  (Positive)

$$q(V_B - V_o)$$



(a)



$V_o$  (Negative)

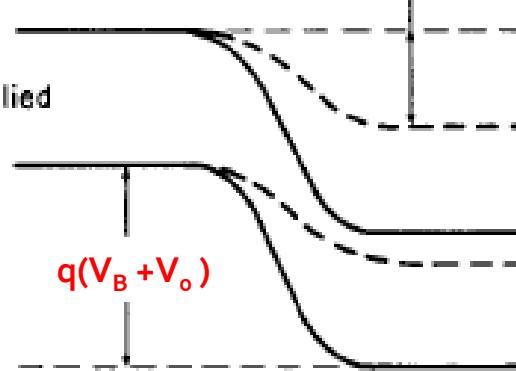
$$qV_B$$

With applied potential

Without applied potential

$$q(V_B + V_o)$$

No applied potential  
With applied potential



(b)

FIGURE 12.4. Potential energy diagrams showing the effect of (a) forward bias and (b) reverse bias voltage upon the energy band configuration at a p-n junction.

Barrier Height decreases under forward bias  $\Rightarrow$  More current  
 Barrier Height increases under reverse bias  $\Rightarrow$  Less Current

# RECAPITULATION

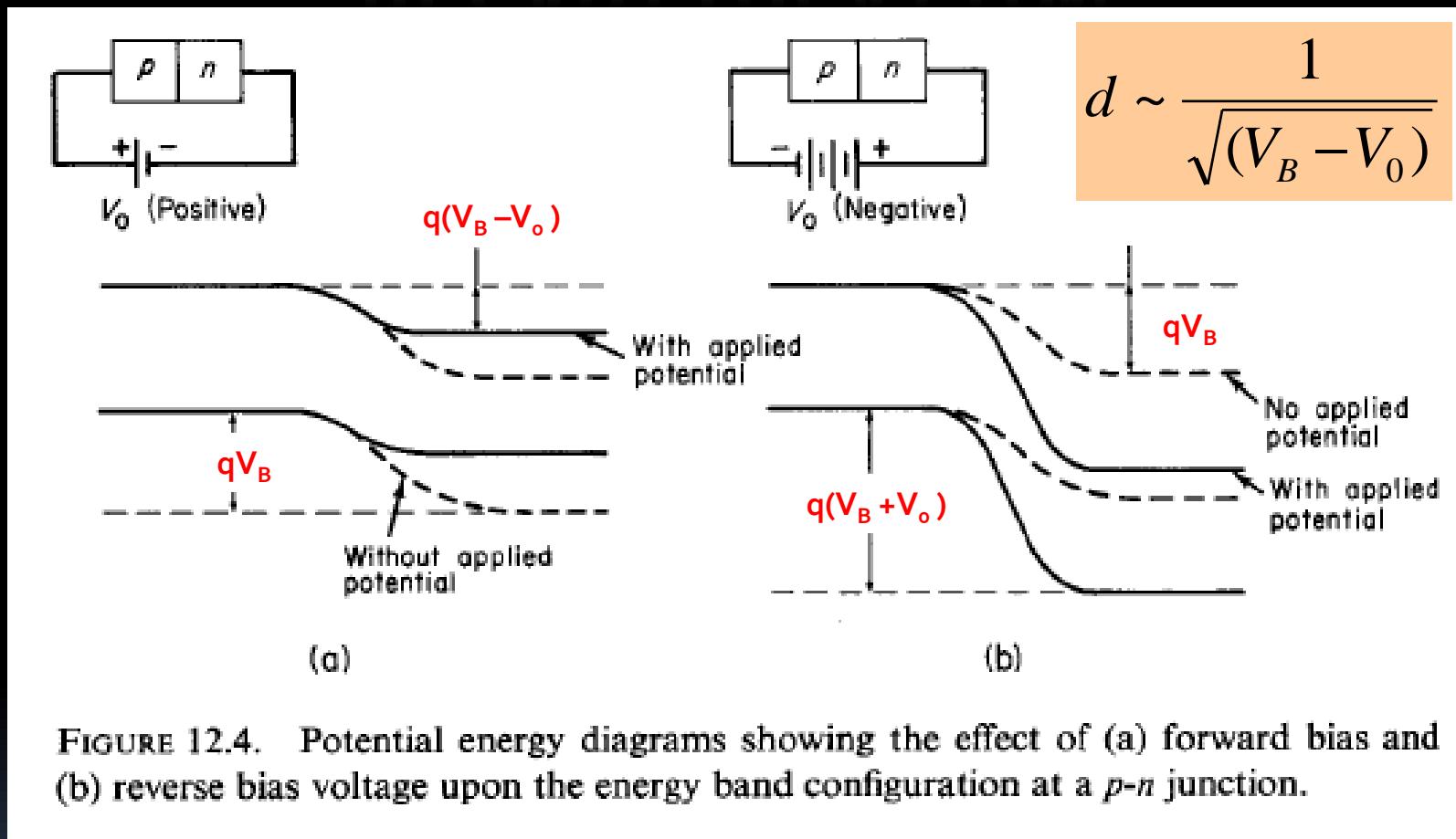
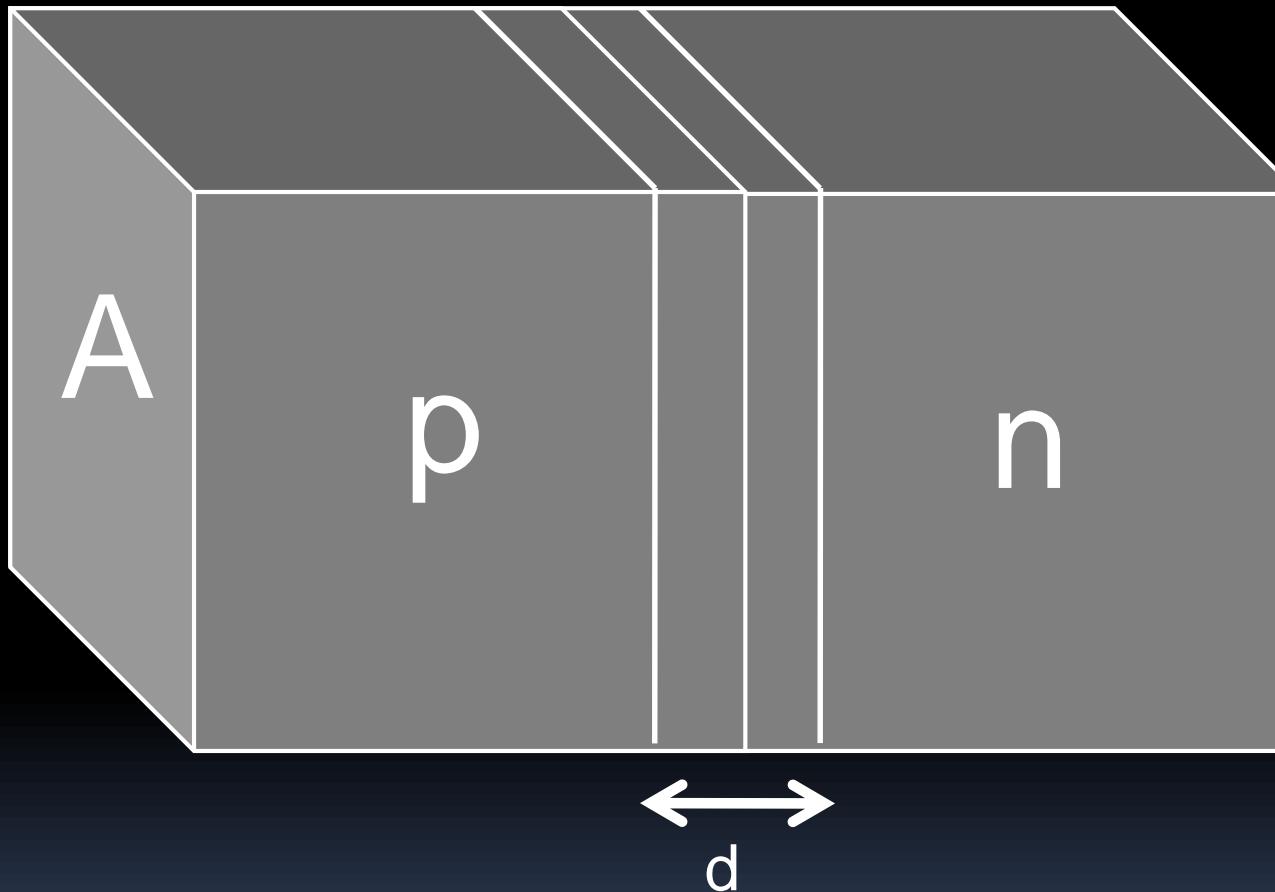


FIGURE 12.4. Potential energy diagrams showing the effect of (a) forward bias and (b) reverse bias voltage upon the energy band configuration at a p-n junction.

Width of the depletion region decreases under forward bias  
 Width of the depletion region increases under reverse bias

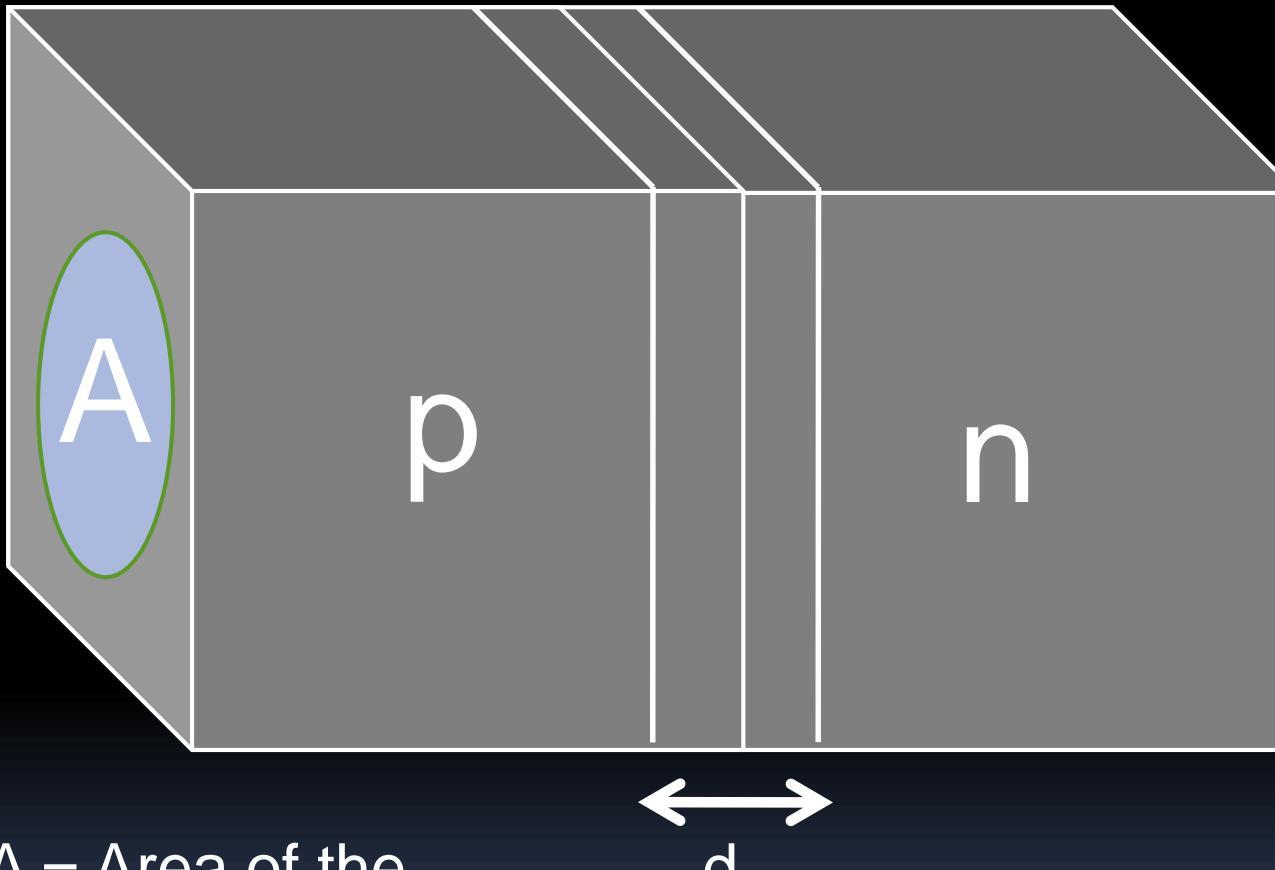
(Figure is not to scale !!) McKelvey, Solid State and Semiconductor Physics

# DEPLETION CAPACITANCE



$$C_J = \frac{\varepsilon \varepsilon_0 A}{d}$$

# DEPLETION CAPACITANCE



$$C_J = \frac{\epsilon \epsilon_0 A}{d}$$

$A$  = Area of the  
Metal Dot

$C$  is not constant, it depends upon applied voltage, therefore it is defined as  $dQ/dV$ .

# DEPLETION CAPACITANCE

$$C_J = \frac{dQ}{dV} = \frac{\epsilon \epsilon_0 A}{d}$$



$$C_J = \frac{1}{\sqrt{V_B - V}}$$

C is not constant, it depends upon applied voltage, therefore it is defined as  $dQ/dV$ .

# DEPLETION CAPACITANCE UNDER FORWARD BIAS

Under Forward bias the capacitance is larger than the static value



The width (d) of the depletion region decrease under forward bias

$$C_J = \frac{\epsilon \epsilon_0 A}{d}$$

# DEPLETION CAPACITANCE UNDER REVERSE BIAS

Under Reverse bias the width (d) of the depletion region increase



Under Reverse bias the capacitance is much smaller than the unbiased static value

$$C_J = \frac{\epsilon \epsilon_0 A}{d}$$

# DIFFUSION (DYNAMIC) CAPACITANCE UNDER FORWARD BIAS

Under Forward bias the capacitance is much larger ( million times !) than the static Depletion Capacitance



Additional Contribution from the accumulation of injected minority carriers near the junction



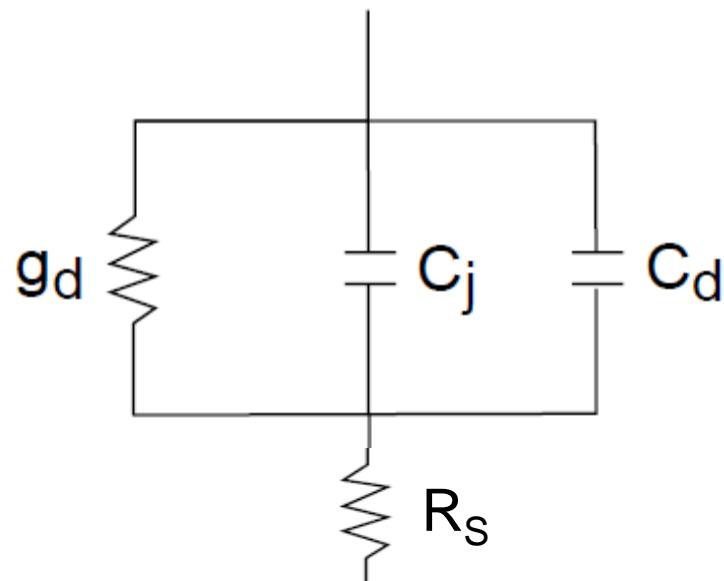
In case of Reverse Bias  
 $C_d$  is negligible compared to depletion capacitance.

$$C_d \approx e^{\frac{qV}{\eta k_B T}} \approx I$$

$C_d$  ( $\sim 1/\omega^{1/2}$ ) is appreciable at Low Frequencies under forward bias.

# EQUIVALENT CIRCUIT OF A P-N JUNCTION DIODE

Complete small-signal equivalent circuit model for diode:



# RECAPITULATION

Depletion Capacitance ( $C_j$ ) increases under forward bias

Depletion Capacitance ( $C_j$ ) decreases under reverse bias

Diffusion Capacitance ( $C_d$ ) increases significantly under forward bias

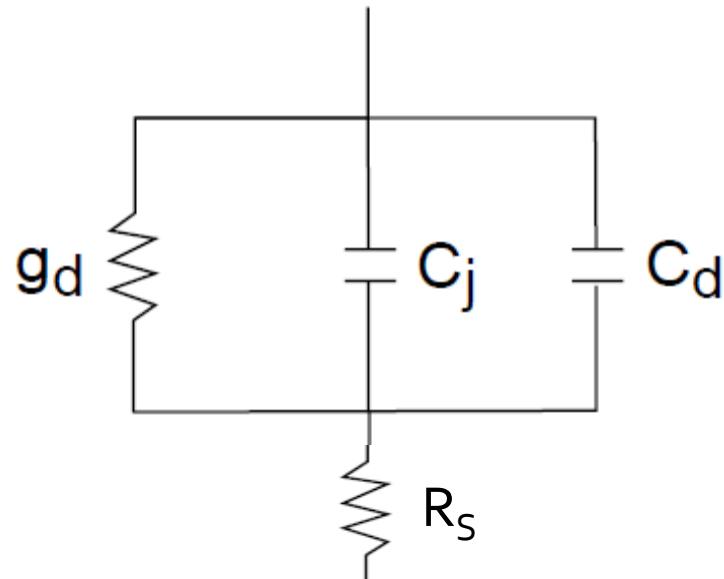
Diffusion Capacitance ( $C_d$ ) is negligible under reverse bias

Incremental conductance ( $g_d$ ) increases significantly under forward bias

Incremental conductance ( $g_d$ ) is negligible under reverse bias

# RECAPITULATION

Complete small-signal equivalent circuit model for diode:



**“DIODE RECTIFY ANY AC SIGNALS”**

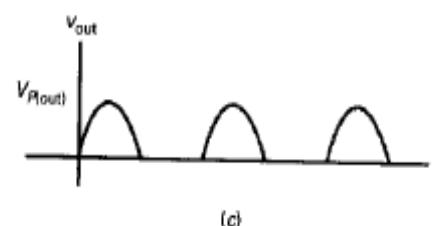
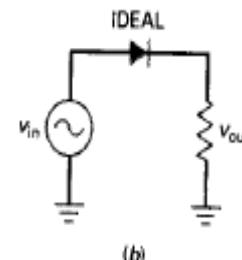
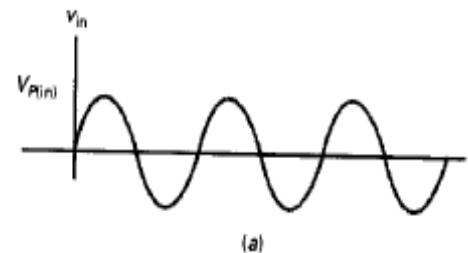
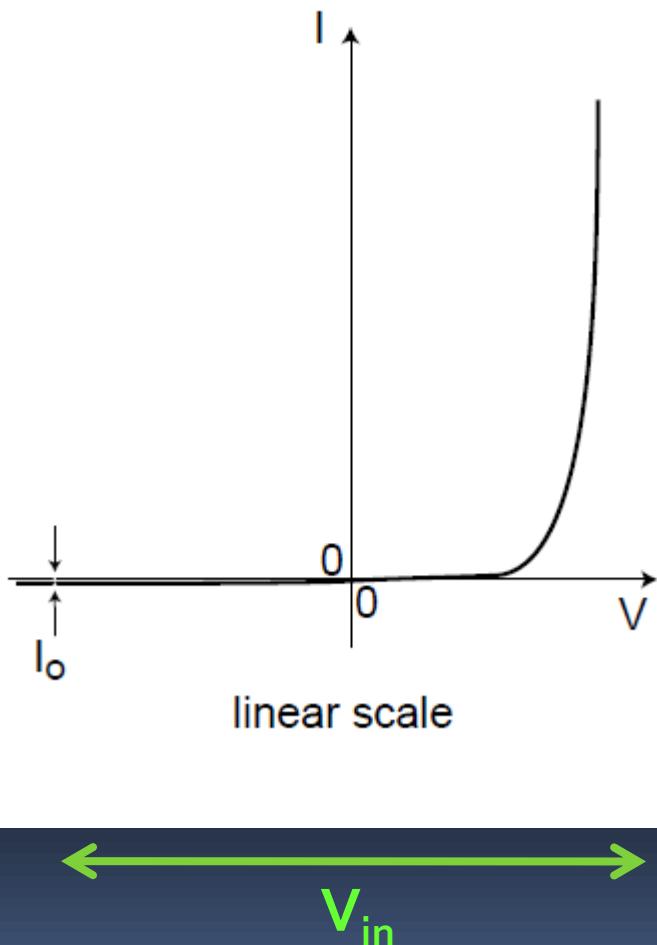
“DIODE RECTIFY ANY AC SIGNALS”



ARE YOU SURE ??

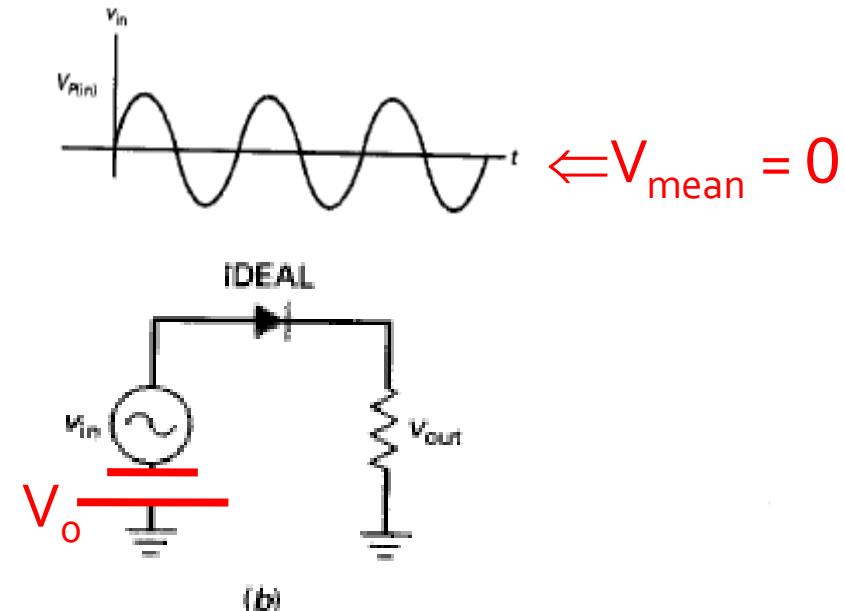
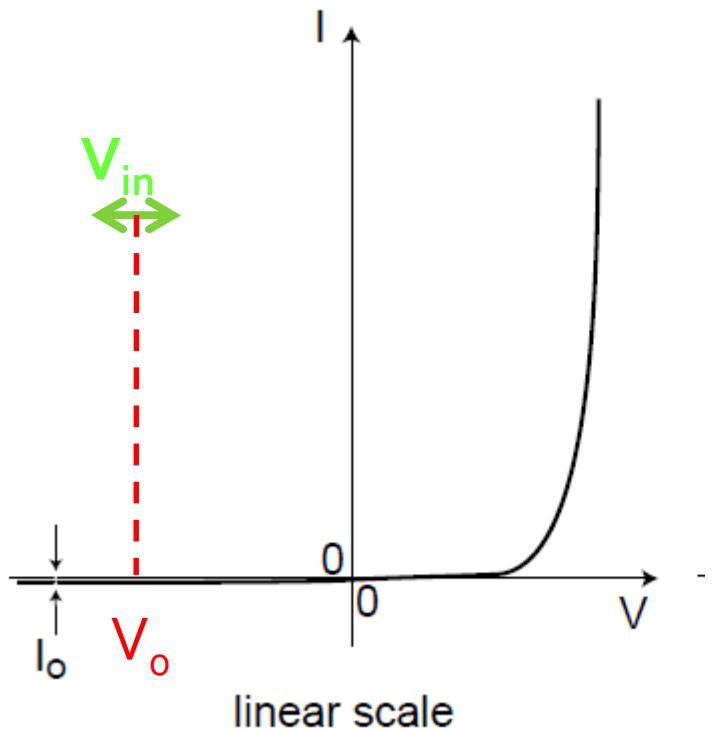
# HOW DIODES RECTIFY AC SIGNALS ?

Figure 4-2 (a) Input to half-wave rectifier; (b) circuit; (c) output of half-wave rectifier.



# IT DOES NOT RECTIFY A SMALL SIGNAL AC AT LARGE REVERSE BIAS

Figure 4-2 (a) Input to half-wave rectifier; (b) circuit; (c) output of half-wave rectifier.



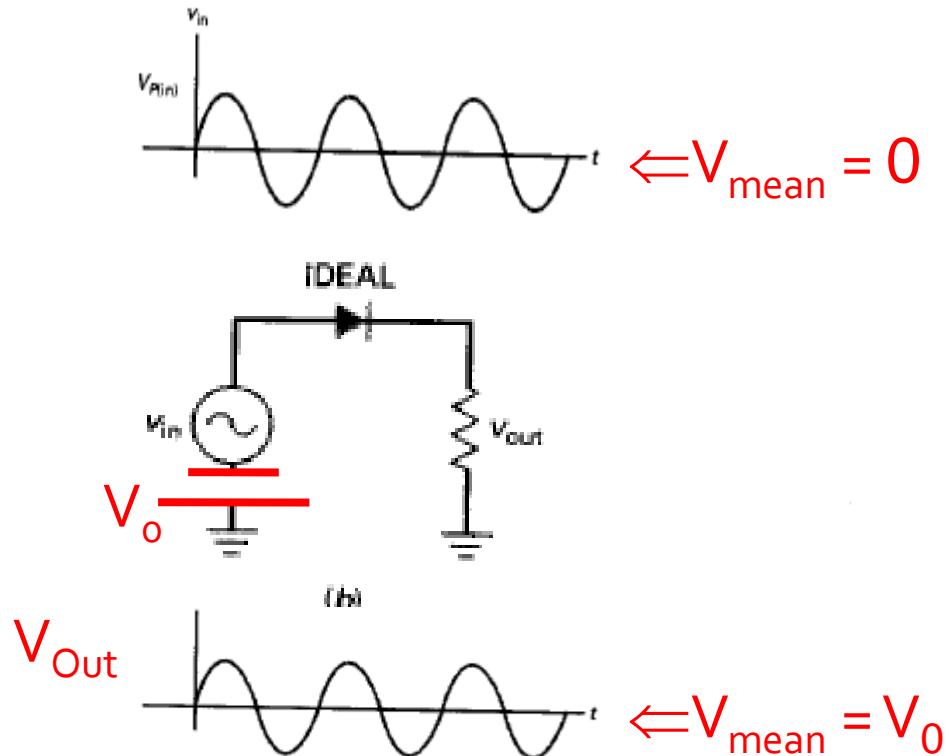
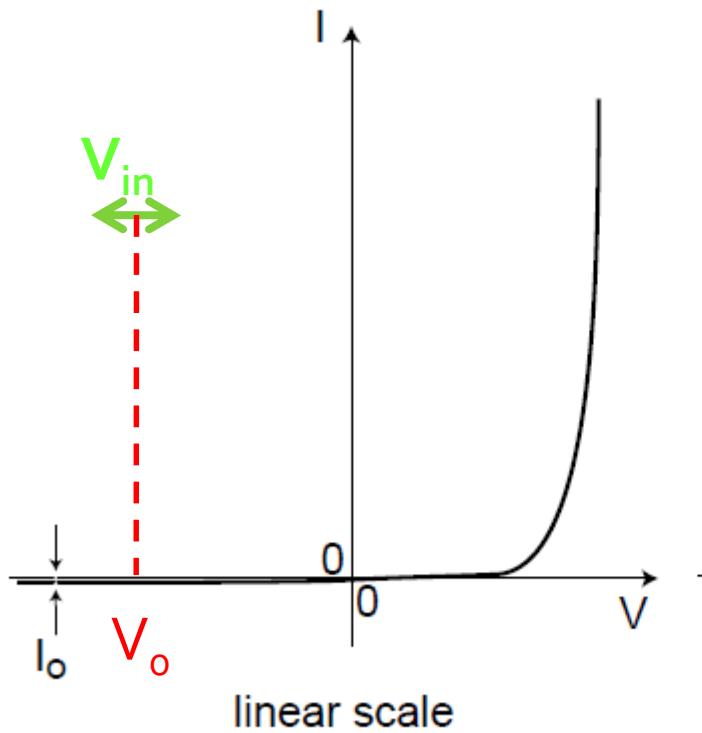
$$V_{\text{Out}} = ??$$

$$V_{\text{Out}} = V_o + V_{\text{in}} = V_o + V_{\text{pp}} \sin(\omega t);$$

Assumption  $V_{\text{pp}} \ll V_o$

# IT DOES NOT RECTIFY A SMALL SIGNAL AC AT LARGE REVERSE BIAS

Figure 4-2 (a) Input to half-wave rectifier; (b) circuit; (c) output of half-wave rectifier.



$$V_{out} = V_o + V_{in} = V_o + V_{pp} \sin(\omega t);$$

Assumption  $V_{pp} \ll V_o$

# DOES NOT RECTIFY A SMALL SIGNAL AC AT LARGE FORWARD BIAS EITHER

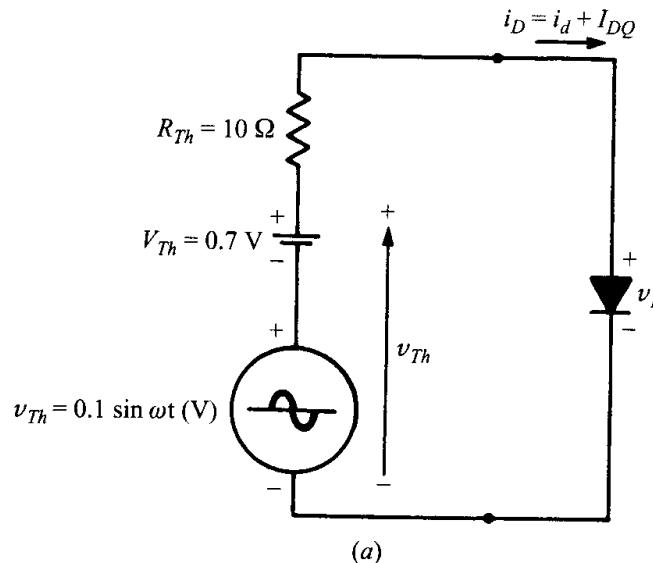
CHAP. 2]

SEMICONDUCTOR DIODES

37

**Example 2.7.** If both dc and time-varying sources are present in the original linear portion of a network, then  $v_{Th}$  is a series combination of a dc and a time-varying source. Suppose that the Thévenin source for a particular network combines a 0.7-V battery and a 0.1-V-peak sinusoidal source, as in Fig. 2-10(a). Find  $i_D$  and  $v_D$  for the network.

We lay out a scaled plot of  $v_{Th}$ , with the  $v_{Th}$  axis parallel to the  $v_D$  axis of the diode characteristic curve. We then consider  $v_{Th}$ , the ac component of  $v_{Th}$ , to be momentarily at zero ( $t = 0$ ), and we plot a load line for this instant



# DOES NOT RECTIFY A SMALL SIGNAL AC AT LARGE FORWARD BIAS EITHER

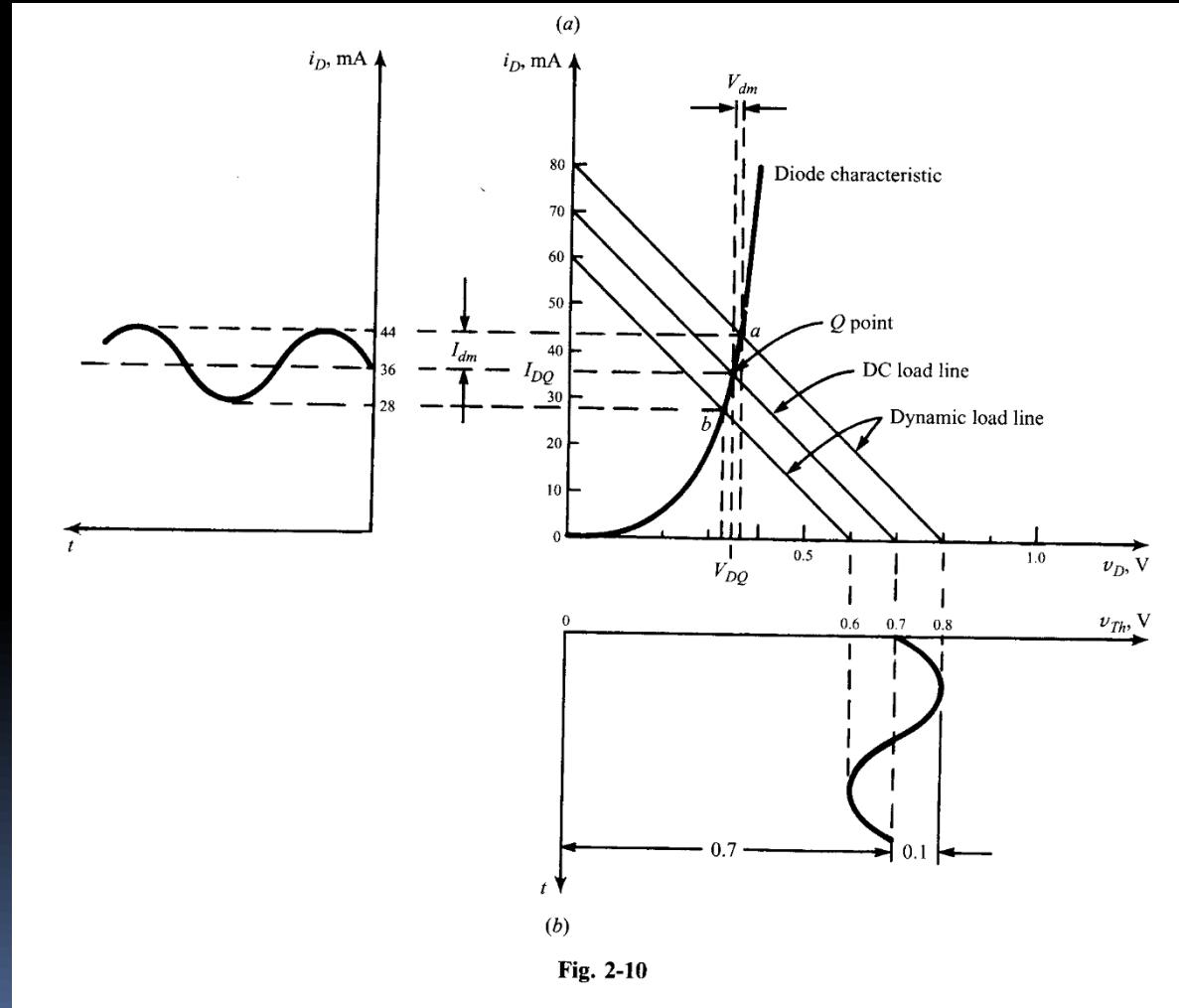
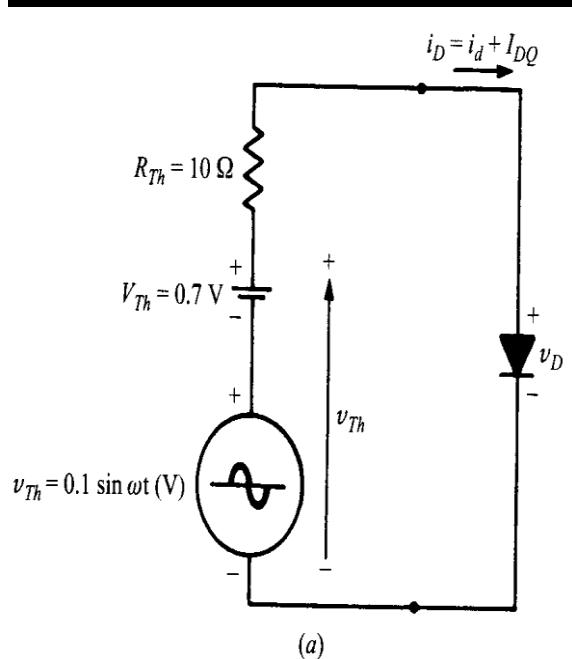
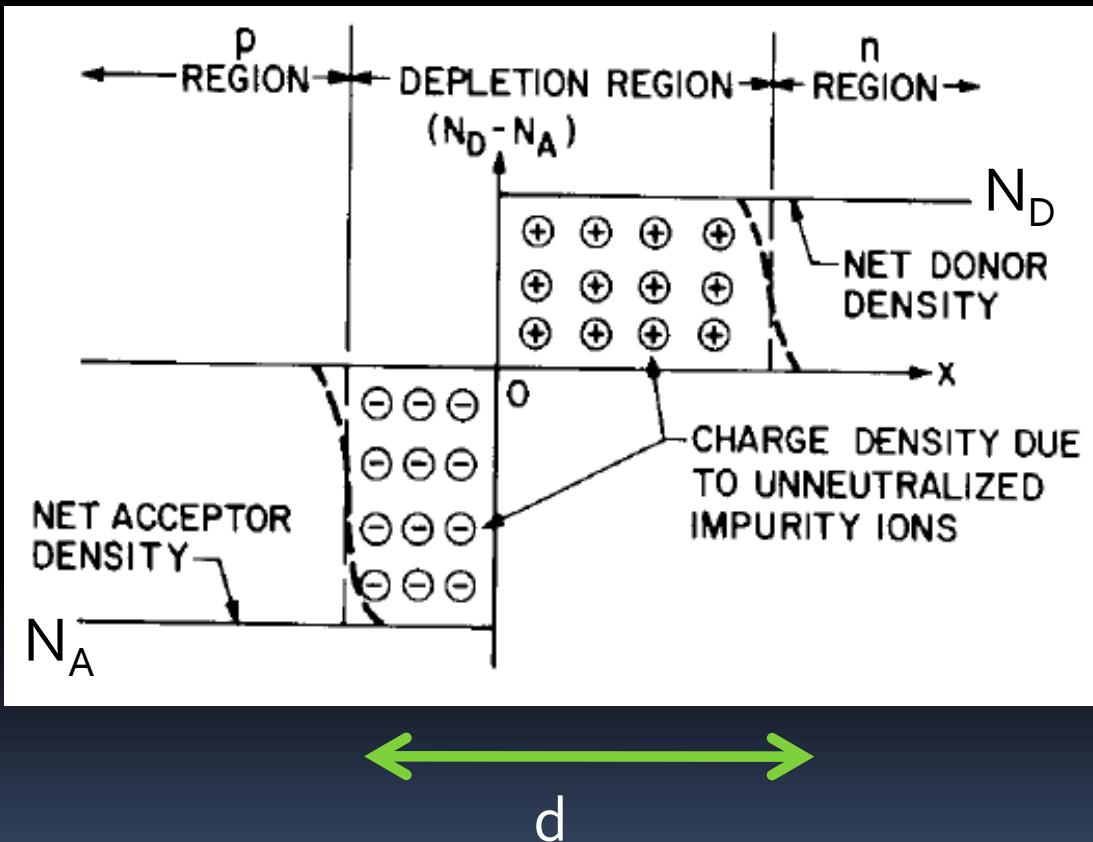


Fig. 2-10

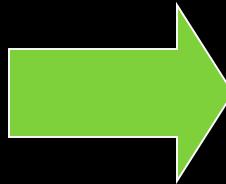
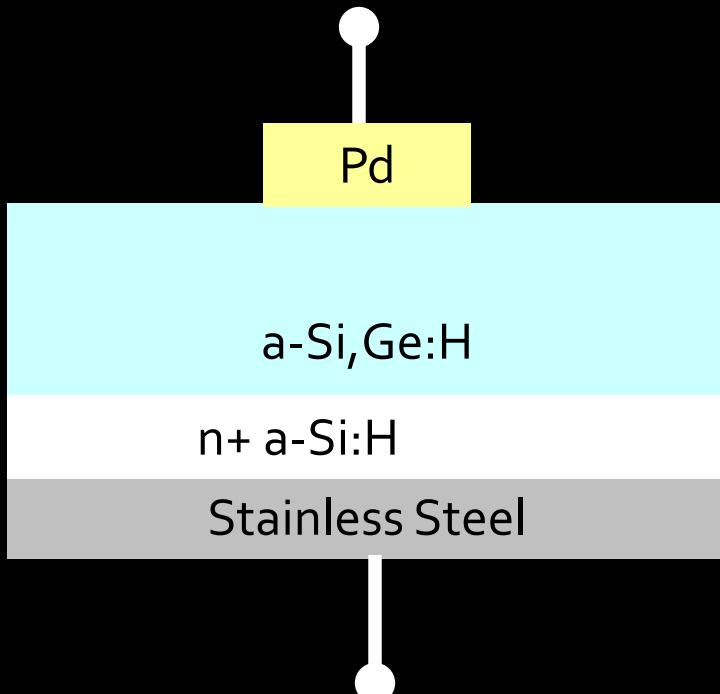
# DEPLETION (JUNCTION) CAPACITANCE



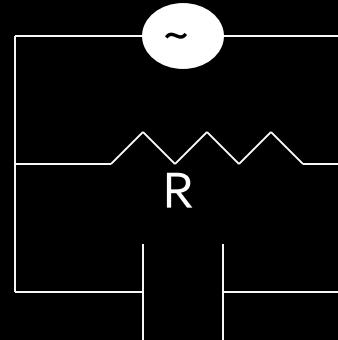
$$C_J = \frac{\epsilon \epsilon_0 A}{d}$$

Capacitance : The Space Charge or the depletion region stores charge

# Admittance Measurements



$$\delta V \sim V_o \sin(\omega_a t)$$

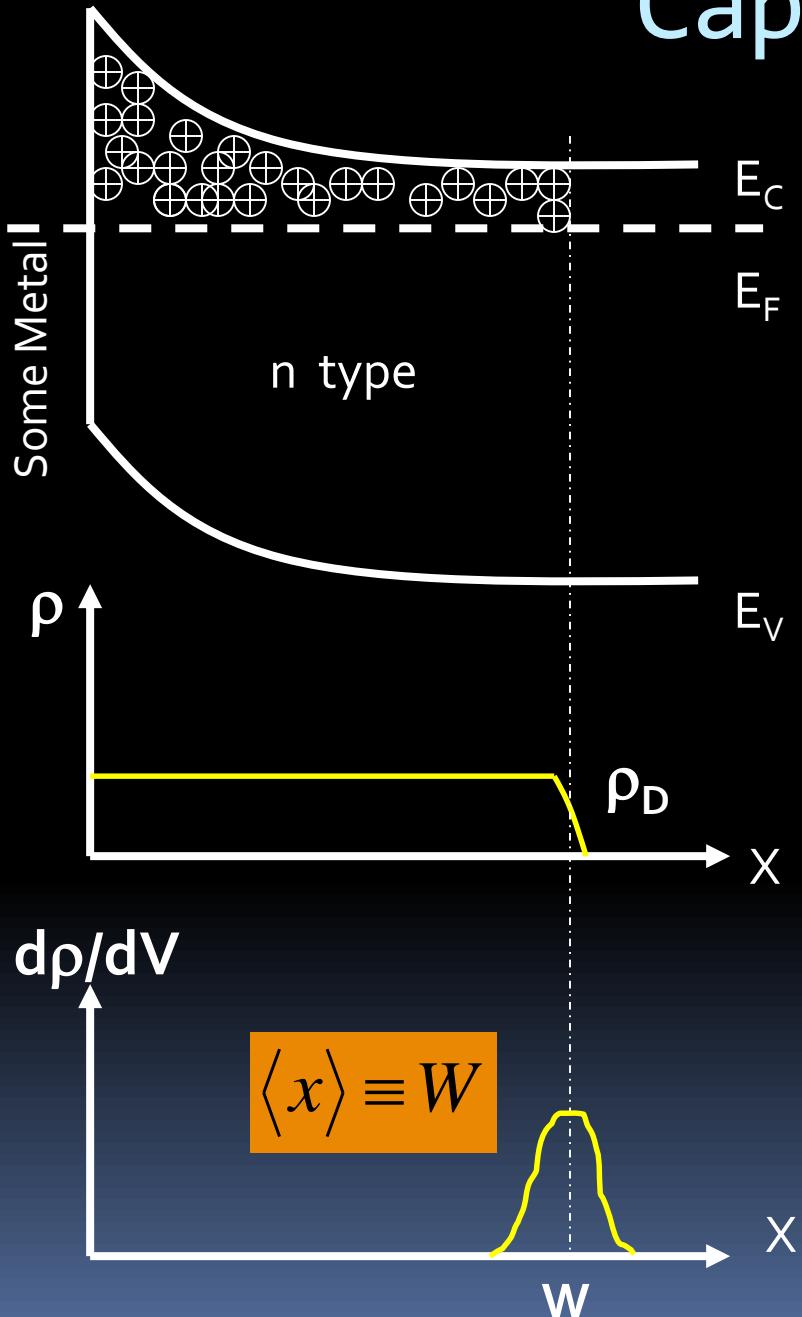


$$\frac{1}{Z_{eq}} = \frac{1}{R} + i\omega_a C = G + i\omega_a C$$

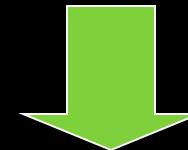
$$i = \frac{dq}{dt} = \left( \frac{dq}{dV} \right) \times \frac{dV}{dt} = C \frac{dV}{dt}$$

Capacitance is estimated by measuring the ac current 90° out of phase with the 'small signal' voltage excitation.

# Capacitance



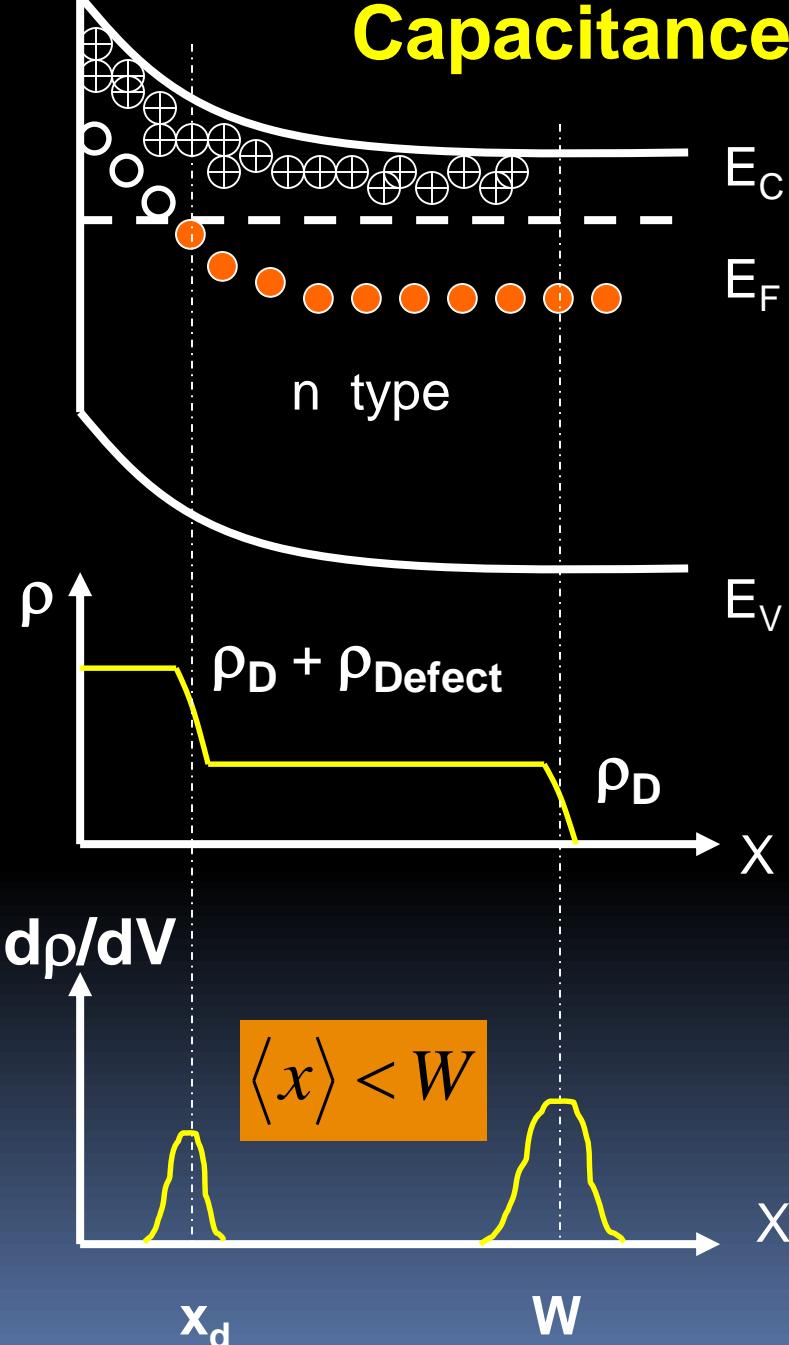
$$C = \frac{dq}{dV} = \frac{\epsilon A \int_0^{\infty} \delta\rho(x) dx}{\int_0^{\infty} x \delta\rho(x) dx} = \frac{\epsilon A}{\langle x \rangle}$$



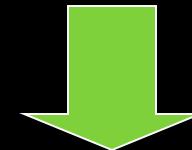
Capacitance is a measure of the mean position of the displaced charge distribution.

H. Kroemer et.al, Sol. State. Electron 24, 655, 1981; David Cohen et.al J. Appl. Phys. 95, 1000 (1995)

# Capacitance with Defect States



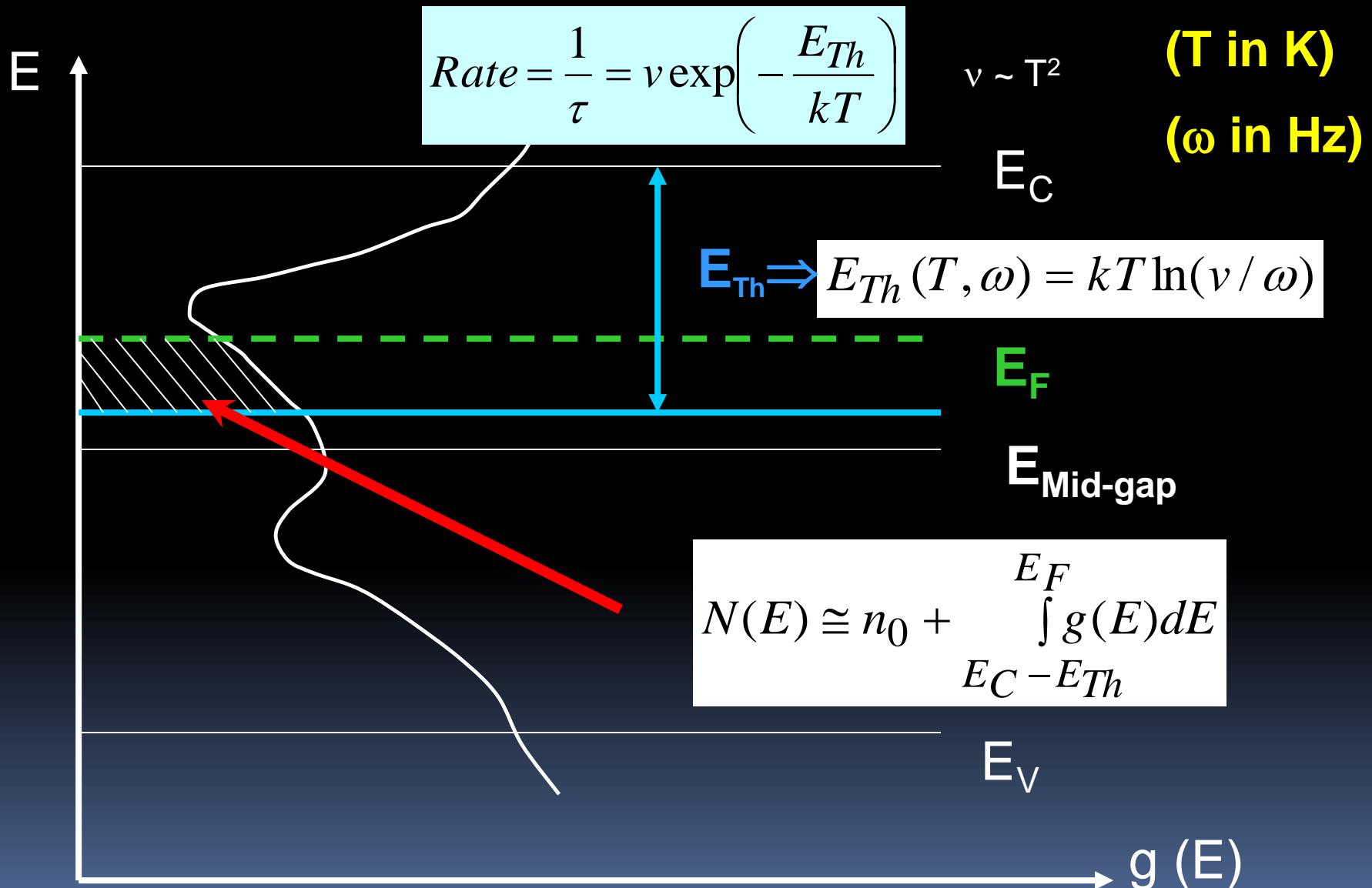
$$C = \frac{dq}{dV} = \frac{\epsilon A \int_0^{\infty} \delta\rho(x) dx}{\int_0^{\infty} x \delta\rho(x) dx} = \frac{\epsilon A}{\langle x \rangle}$$



Capacitance is a measure of  
the mean position of the  
displaced charge distribution.

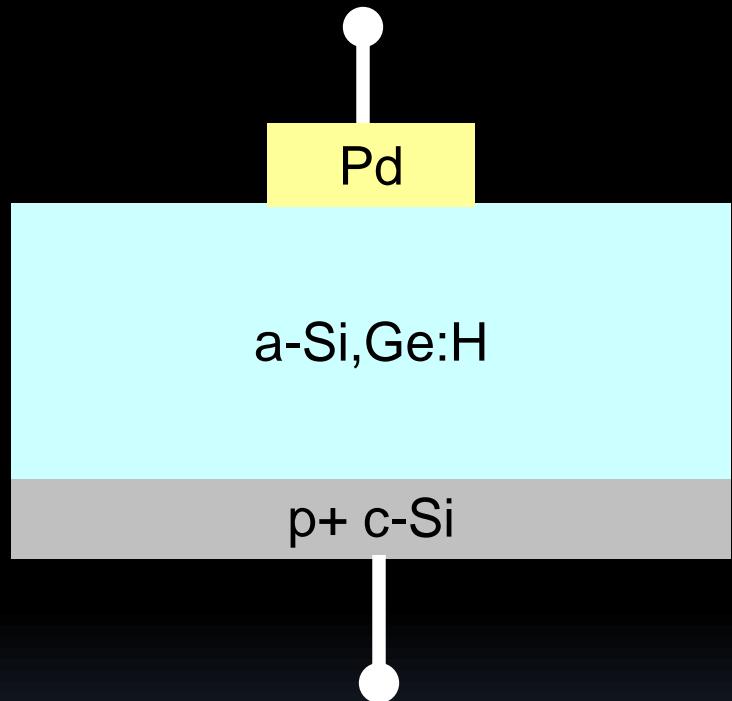
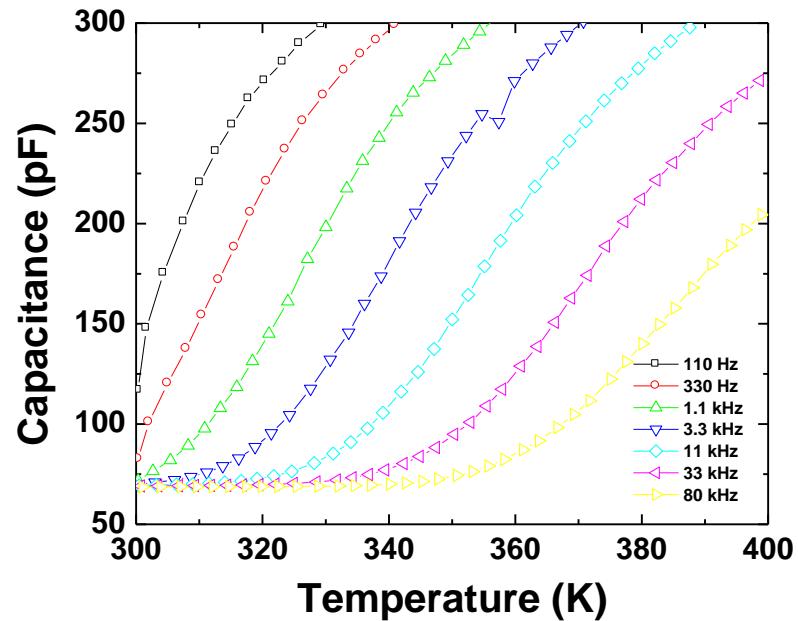
H. Kroemer et.al, Sol. State. Electron 24,  
655, 1981; David Cohen et.al J. Appl.  
Phys. 95, 1000 (1995)

# Temperature and Frequency Dependence of Thermally Activated Processes



# Admittance Measurements

HWCVD a-Si,Ge;H with 30%Ge and  $>10^{20}/\text{cm}^3 \text{ O}_2$  on p<sup>+</sup> c-Si

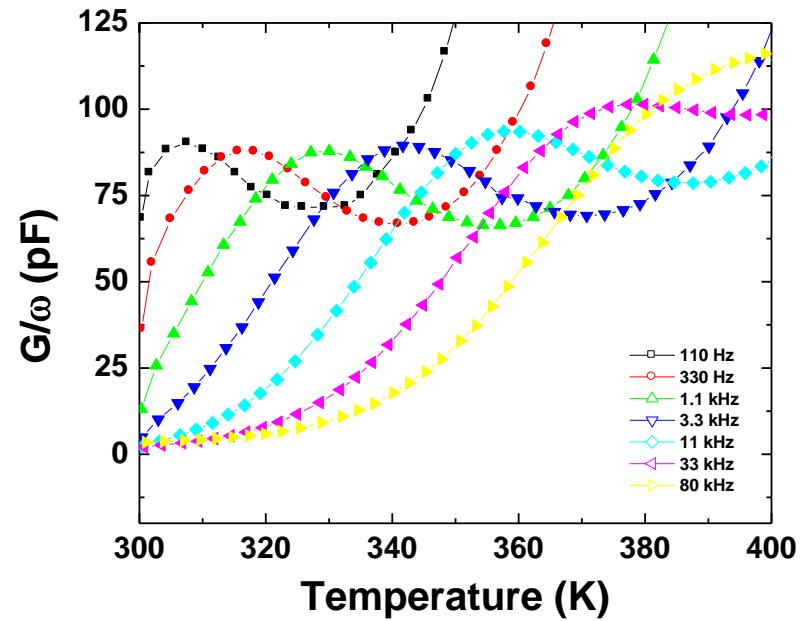
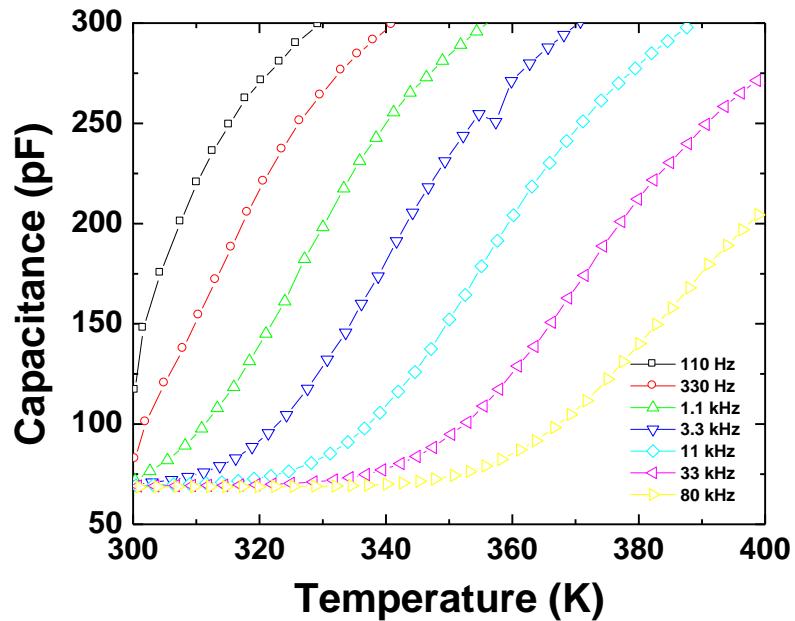


$$C = \frac{\epsilon A}{t} \Rightarrow \frac{\epsilon A}{\langle x \rangle}$$

Thickness of the Film ( t ) > Effective Depletion Width (  $\langle x \rangle$  )  
'A' is the area of the top semi-transparent Pd dot

# Admittance Measurements

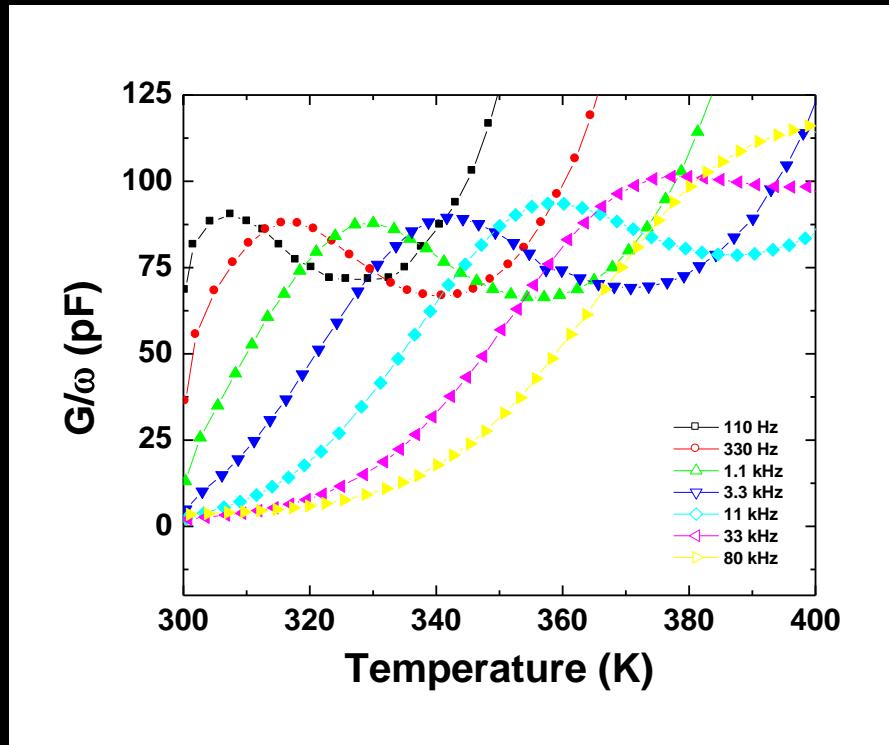
HWCVD a-Si,Ge;H with 30%Ge and  $>10^{20}/\text{cm}^3$  O<sub>2</sub> on p<sup>+</sup> c-Si



Conductance Peaks  $\Rightarrow E_{Th}(T, \omega) \equiv E_F$

$$E_{Th}(T, \omega) = kT \ln(\nu / \omega)$$

# Activation of Conduction



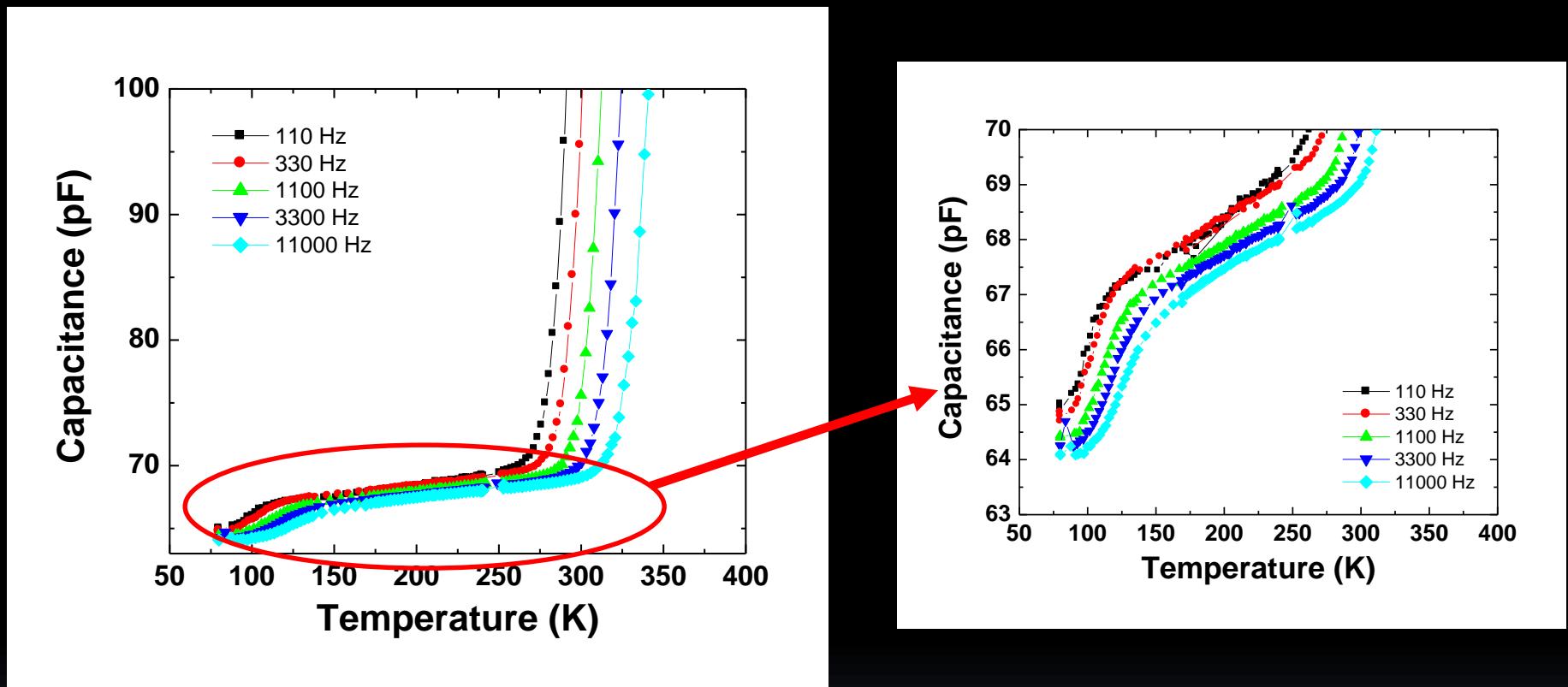
$G \Rightarrow$  Conductance ( $\text{Ohm}^{-1}$ )

$k_B \Rightarrow$  Boltzmann Constant ( $8.617\ 343 \times 10^{-5}\ \text{eV}\ \text{K}^{-1}$  )

$\omega \Rightarrow$  Frequency of Measurement (Hz)

$E_a \Rightarrow$  Activation Energy (eV)

# Signature of Doping – Activation of Shallow States



$$C_{Low\;Temp} = \frac{\epsilon A}{t}; \quad t = Film\;Thickness$$

2006 HWCVD a-Si,Ge:H with 30% Ge / n<sup>+</sup> a-Si:H / Stainless Steel